

# RADIATION HARDENED LOW POWER NPN SILICON TRANSISTOR

Qualified per MIL-PRF-19500/391

DESCRIPTION

This NPN ceramic surface mount device is RAD hard qualified for high-reliability applications. Microsemi also offers numerous other products to meet higher and lower power voltage regulation applications.

Important: For the latest information, visit our website http://www.microsemi.com.

FEATURES

- Surface mount equivalent to JEDEC registered 2N3700.
- RHA level JAN qualifications per MIL-PRF-19500/391 (see part nomenclature for all options).

## **APPLICATIONS / BENEFITS**

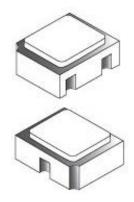
- Ceramic UB surface mount package.
- Lightweight.
- Low power.
- Military and other high-reliability applications.

### **MAXIMUM RATINGS** @ $T_A = +25 \,^{\circ}C$ unless otherwise noted.

| Parameters/Test Conditions                      | Symbol                        | Value       | Unit |
|---|-------------------------------|-------------|------|
| Junction and Storage Temperature                | $T_{\rm J}$ and $T_{\rm STG}$ | -65 to +200 | °C   |
| Thermal Impedance Junction-to-Ambient           | R <sub>OJA</sub>              | 325         | °C/W |
| Thermal Impedance Junction-to-Case              | R <sub>ØJSP</sub>             | 90          | °C/W |
| Collector-Emitter Voltage                       | V <sub>CEO</sub>              | 80          | V    |
| Collector-Base Voltage                          | V <sub>CBO</sub>              | 140         | V    |
| Emitter-Base Voltage                            | V <sub>EBO</sub>              | 7.0         | V    |
| Collector Current                               | Ι <sub>C</sub>                | 1.0         | Α    |
| Total Power Dissipation: $@ T_A = +25 °C^{(1)}$ | PD                            | 0.5         | W    |

**<u>Notes</u>**: 1. Derate linearly 6.6 mW/°C for  $T_A \ge +25$  °C.

<u>Qualified Levels</u>: JANSM, JANSD, JANSP, JANSL, and JANSR



**UB** Package

## Also available in:

TO-18 (TO-206AA) (leaded) JANS 2N3700

## TO-39 (TO-205AD)

(leaded) JANS\_2N3019, 2N3019S

TO-46 (TO-206AB) (leaded) JANS 2N3057A

MSC – Lawrence

6 Lake Street, Lawrence, MA 01841 Tel: 1-800-446-1158 or (978) 620-2600 Fax: (978) 689-0803

### MSC – Ireland

Gort Road Business Park, Ennis, Co. Clare, Ireland Tel: +353 (0) 65 6840044 Fax: +353 (0) 65 6822298

Website:

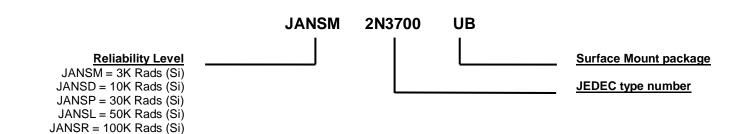
www.microsemi.com



## **MECHANICAL and PACKAGING**

- CASE: Ceramic.
- TERMINALS: Gold plating over nickel under plate.
- MARKING: Part number, date code, manufacturer's ID, and serial number.
- TAPE & REEL option: Standard per EIA-418D. Consult factory for quantities.
- WEIGHT: < 0.04 Grams.
- See <u>Package Dimensions</u> on last page.

#### PART NOMENCLATURE



|                 | SYMBOLS & DEFINITIONS             |  |  |  |  |  |
|-----------------|-----------------------------------|--|--|--|--|--|
| Symbol          | Definition                        |  |  |  |  |  |
| f               | frequency                         |  |  |  |  |  |
| I <sub>B</sub>  | Base current (dc)                 |  |  |  |  |  |
| Ι <sub>Ε</sub>  | Emitter current (dc)              |  |  |  |  |  |
| T <sub>A</sub>  | Ambient temperature               |  |  |  |  |  |
| Tc              | Case temperature                  |  |  |  |  |  |
| V <sub>CB</sub> | Collector to base voltage (dc)    |  |  |  |  |  |
| V <sub>CE</sub> | Collector to emitter voltage (dc) |  |  |  |  |  |
| V <sub>EB</sub> | Emitter to base voltage (dc)      |  |  |  |  |  |



| Parameters / Test Conditions  | Symbol               | Min.                        | Max.              | Unit |  |
|---|----------------------|-----------------------------|-------------------|------|--|
| OFF CHARACTERTICS   |                      |                             | L                 |      |  |
| Collector-Emitter Breakdown Current $I_{C} = 30 \text{ mA}$   | V <sub>(BR)CEO</sub> | 80                          |                   | V    |  |
| Collector-Base Cutoff Current $V_{CB} = 140 V$  | I <sub>CBO</sub>     |                             | 10                | μA   |  |
| Emitter-Base Cutoff Current $V_{EB} = 7 V$  | I <sub>EBO1</sub>    |                             | 10                | μA   |  |
| Collector-Emitter Cutoff Current<br>V <sub>CE</sub> = 90 V  | I <sub>CES</sub>     |                             | 10                | ηA   |  |
| Emitter-Base Cutoff Current $V_{EB} = 5.0 V$  | I <sub>EBO2</sub>    |                             | 10                | ηA   |  |
| ON CHARACTERISTICS (1)  |                      |                             |                   |      |  |
| Forward-Current Transfer Ratio<br>$I_{C} = 150 \text{ mA}, V_{CE} = 10 \text{ V}$<br>$I_{C} = 0.1 \text{ mA}, V_{CE} = 10 \text{ V}$<br>$I_{C} = 10 \text{ mA}, V_{CE} = 10 \text{ V}$<br>$I_{C} = 500 \text{ mA}, V_{CE} = 10 \text{ V}$<br>$I_{C} = 1.0 \text{ A}, V_{CE} = 10 \text{ V}$ | h <sub>FE</sub>      | 100<br>50<br>90<br>50<br>15 | 300<br>300<br>300 |      |  |
| Collector-Emitter Saturation Voltage<br>$I_{C} = 150 \text{ mA}, I_{B} = 15 \text{ mA}$<br>$I_{C} = 500 \text{ mA}, I_{B} = 50 \text{ mA}$  | V <sub>CE(sat)</sub> |                             | 0.2<br>0.5        | V    |  |
| Base-Emitter Saturation Voltage $I_{C} = 150 \text{ mA}, I_{B} = 15 \text{ mA}$   | V <sub>BE(sat)</sub> |                             | 1.1               | V    |  |

## ELECTRICAL CHARACTERISTICS @ T<sub>A</sub> = +25 °C, unless otherwise noted

## DYNAMIC CHARACTERISTICS

| Parameters / Test Conditions  | Symbol           | Min. | Max. | Unit |
|---|------------------|------|------|------|
| Small-Signal Short-Circuit Forward Current Transfer Ratio $I_{C} = 1.0 \text{ mA}, V_{CE} = 5.0 \text{ V}, f = 1.0 \text{ kHz}$                         | h <sub>fe</sub>  | 80   | 400  |      |
| Magnitude of Small-Signal Short-Circuit Forward Current<br>Transfer Ratio<br>$I_{C} = 50 \text{ mA}, V_{CE} = 10 \text{ V}, \text{ f} = 20 \text{ MHz}$ | h <sub>fe</sub>  | 5.0  | 20   |      |
| Output Capacitance<br>$V_{CB} = 10 \text{ V}, I_E = 0, 100 \text{ kHz} \le f \le 1.0 \text{ MHz}$   | C <sub>obo</sub> |      | 12   | pF   |
| Input Capacitance<br>V <sub>EB</sub> = 0.5 V, $I_C$ = 0, 100 kHz ≤ f ≤ 1.0 MHz  | $C_{ibo}$        |      | 60   | pF   |

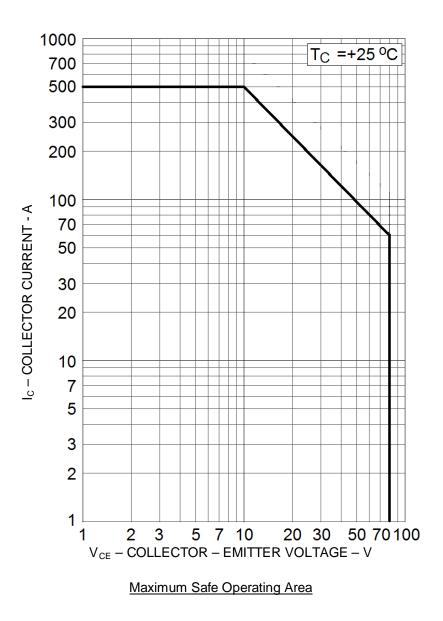
(1) Pulse Test: Pulse Width = 300  $\mu$ s, duty cycle ≤ 2.0%.



## ELECTRICAL CHARACTERISTICS @ T<sub>A</sub> = +25 °C, unless otherwise noted (continued)

SAFE OPERATION AREA (See SOA graph below and MIL-STD-750, method 3053)

| <b>DC Tests</b><br>$T_c = 25 \text{ °C}, 1 \text{ cycle}, t = 10 \text{ ms}$ |                          |
|--|--------------------------|
| <b>Test 1</b>  | V <sub>CE</sub> = 10 V   |
| 2N3700UB   | I <sub>C</sub> = 180 mA  |
| <b>Test 2</b>  | V <sub>CE</sub> = 40 V   |
| 2N3700UB   | I <sub>C</sub> = 45 mA   |
| <b>Test 3</b>  | V <sub>CE</sub> = 80 V   |
| 2N3700UB   | I <sub>C</sub> = 22.5 mA |





## **ELECTRICAL CHARACTERISTICS** @ $T_A = +25$ °C, unless otherwise noted (continued)

## POST RADIATION ELECTRICAL CHARACTERISTICS

| Parameters / Test Conditions   | Symbol               | Min.  | Max.         | Unit |  |
|--|----------------------|-------|--------------|------|--|
| Collector to Base Cutoff Current $V_{CB} = 140 V$  | I <sub>CBO</sub>     |       | 20           | μA   |  |
| Emitter to Base Cutoff Current $V_{EB} = 7 V$  | I <sub>EBO</sub>     |       | 20           | μA   |  |
| Collector to Emitter Breakdown Voltage $I_{C} = 30 \text{ mA}$   | V <sub>(BR)CEO</sub> | 80    |              | V    |  |
| Collector-Emitter Cutoff Current<br>V <sub>CE</sub> = 90 V   | I <sub>CES</sub>     |       | 20           | ηA   |  |
| Emitter-Base Cutoff Current $V_{EB} = 5.0 V$   | I <sub>EBO</sub>     |       | 20           | ηA   |  |
| Forward-Current Transfer Ratio <sup>(2)</sup><br>$I_{C} = 150 \text{ mA}, V_{CE} = 10 \text{ V}$   |                      | [50]  | 300          |      |  |
| $I_{\rm C}$ = 0.1 mA, $V_{\rm CE}$ = 10 V  |                      | [25]  | 300          |      |  |
| $I_{C} = 10 \text{ mA}, V_{CE} = 10 \text{ V}$   | [h <sub>FE</sub> ]   | [45]  |              |      |  |
| $I_{C} = 500 \text{ mA}, V_{CE} = 10 \text{ V}$  |                      | [25]  | 300          |      |  |
| I <sub>C</sub> = 1 A, V <sub>CE</sub> = 10 V   |                      | [7.5] |              |      |  |
| Collector-Emitter Saturation Voltage<br>$I_{C} = 150 \text{ mA}, I_{B} = 15 \text{ mA}$<br>$I_{C} = 500 \text{ mA}, I_{B} = 50 \text{ mA}$ | V <sub>CE(sat)</sub> |       | 0.23<br>0.58 | V    |  |
| Base-Emitter Saturation Voltage $I_{C} = 150 \text{ mA}, I_{B} = 15 \text{ mA}$  | $V_{BE(sat)}$        |       | 1.27         | V    |  |

(2) See method 1019 of MIL-STD-750 for how to determine  $[h_{FE}]$  by first calculating the delta  $(1/h_{FE})$  from the pre- and postradiation  $h_{FE}$ . Notice the  $[h_{FE}]$  is not the same as  $h_{FE}$  and cannot be measured directly. The  $[h_{FE}]$  value can never exceed the pre-radiation minimum  $h_{FE}$  that it is based upon.



GRAPHS

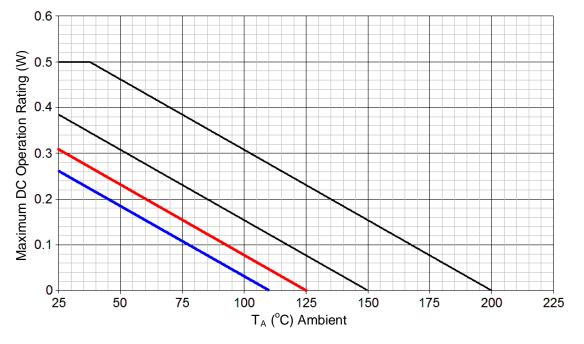
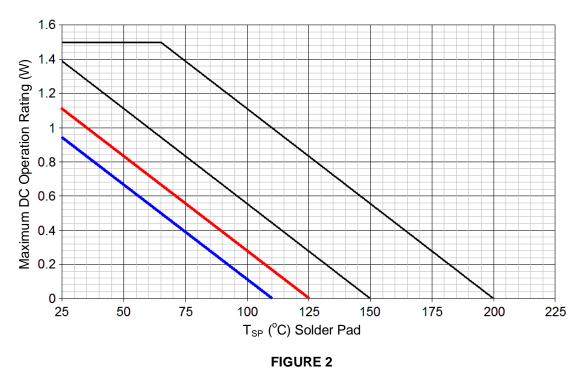


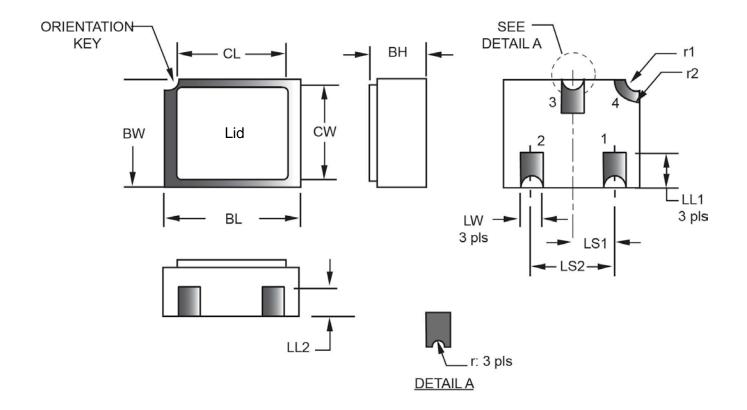
FIGURE 1 Temperature-Power Derating (R<sub>OJA</sub>)



<u>Temperature-Power Derating ( $R_{\Theta JSP}$ )</u>



## PACKAGE DIMENSIONS



| Symbol          | Dimensions |      |             |      |      | Dimensions      |      |      |             |      |      |
|-----------------|------------|------|-------------|------|------|-----------------|------|------|-------------|------|------|
|                 | Inch       |      | Millimeters |      | Note | Symbol          | Inch |      | Millimeters |      | Note |
| -               | Min        | Max  | Min         | Max  |      | -               | Min  | Max  | Min         | Max  |      |
| BH              | .046       | .056 | 1.17        | 1.42 |      | LS <sub>1</sub> | .036 | .040 | .091        | 1.02 |      |
| BL              | .115       | .128 | 2.92        | 3.25 |      | LS <sub>2</sub> | .071 | .079 | 1.81        | 2.01 |      |
| BW              | .085       | .108 | 2.16        | 2.74 |      | LW              | .016 | .024 | 0.41        | 0.61 |      |
| CL              |            | .128 |             | 3.25 |      | r               |      | .008 |             | .203 |      |
| CW              |            | .108 |             | 2.74 |      | <b>r</b> 1      |      | .012 |             | .305 |      |
| LL <sub>1</sub> | .022       | .038 | 0.56        | 0.96 |      | r <sub>2</sub>  |      | .022 |             | .559 |      |
| LL <sub>2</sub> | .017       | .035 | 0.43        | 0.89 |      |                 |      |      |             |      |      |

## NOTES:

- 1. Dimensions are in inches.
- 2. Millimeters are given for general information only.
- 3. Hatched areas on package denote metallized areas.
- 4. Pad 1 = Base, Pad 2 = Emitter, Pad 3 = Collector, Pad 4 = Shielding connected to the lid.
- 5. In accordance with ASME Y14.5M, diameters are equivalent to  $\Phi x$  symbology.

Downloaded from Arrow.com.